



1FW # 2827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application

Inventor: Charles A. Miller
Appln. No.: 09/970,749
Confirm. No.: 1647
Filed: October 3, 2001
Title: Multiple Die Interconnect System

PATENT APPLICATION

Art Unit: 2827
Examiner: Dinh, Tuan T.
Customer No. 23910

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

I hereby certify that this correspondence is being deposited in the United States Postal Service with sufficient postage as first class mail in an envelope addressed to **Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450**, on April 27, 2004.

Thomas A. Ward _____ (Attorney Signature)
Thomas A. Ward, Reg. 35,732
Signature Date: April 27, 2004

RESPONSE TRANSMITTAL LETTER

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted with this communication in connection with the above-identified application are the following:

✓

A Response under 37 C.F.R. §1.111 to the Office Action dated January 27, 2004.

The fee associated with this communication has been calculated as shown below:

✓ A fee for addition of claims under 37 C.F.R. §1.16 is due as follows:

FEES	Claims Remaining After Amendment	Highest Number Previously Paid For	Present Extra	Rate Small Entity/Other Than Small Entity	Total
TOTAL CLAIMS (37 CFR 1.16(c))	<u>39</u> * -	<u>38</u> **	<u>1</u>	X \$ 9.00 X \$ 18.00	\$18.00
INDEPENDENT CLAIMS (37 CFR 1.16(b))	<u>6</u> * -	<u>4</u> ***	<u>2</u>	X \$ 43.00 X \$ 86.00	\$172.00
				TOTAL	\$190.00

The total fee required with this communication is \$190.00 and is to be paid as follows:

✓ Please charge Deposit Account No. 06-1325 in the amount of \$190.00.

✓ The Commissioner is hereby authorized to charge any deficiencies or credit overpayment to Deposit Account No. 06-1325.

Respectfully submitted,

Date: 4/27/04

By: Thomas Ward
Thomas A. Ward, Reg. 35,732

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application

Inventors: Charles A. Miller

SC/Serial No.: 09/970,749

Confirm. No.: 1647

Filed: October 3, 2001

Title: MULTIPLE DIE INTERCONNECT SYSTEM

PATENT APPLICATION

Art Unit: 2827

Examiner: Dinh, Tuan T.

Customer No. 23910

RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed January 27, 2004, please amend the above-identified application as follows:

In the Claims:

Please amend claims 21, 28 and 29, and add new claim 39 as indicated in the list of claims beginning on the following page.

04/30/2004 FMETEKI1 00000071 061325 09970749

01 FC:1202 18.00 DA
02 FC:1201 172.00 DA